SCDS025P - MAY 1995 - REVISED JUNE 2001

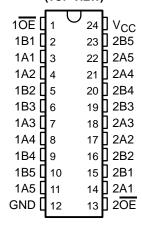
- 5-Ω Switch Connection Between Two Ports
- TTL-Compatible Input Levels
- Designed to Be Used in Level-Shifting Applications

description

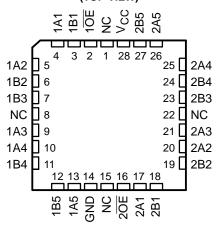
The 'CBTD3384 devices provide ten bits of high-speed TTL-compatible bus switching. The low on-state resistance of the switches allows connections to be made without adding propagation delay. A diode to V_{CC} is integrated on the die to allow for level shifting between 5-V inputs and 3.3-V outputs.

These devices are organized as two 5-bit switches with separate output-enable (\overline{OE}) inputs. When \overline{OE} is low, the switch is on, and port A is connected to port B. When \overline{OE} is high, the switch is open, and the high-impedance state exists between the two ports.

SN54CBTD3384 . . . JT OR W PACKAGE SN74CBTD3384 . . . DB, DBQ, DGV, DW, OR PW PACKAGE (TOP VIEW)



SN54CBTD3384 ... FK PACKAGE (TOP VIEW)



NC - No internal connection

ORDERING INFORMATION

TA	PACKAGE [†]		ORDERABLE PART NUMBER	TOP-SIDE MARKING	
	SOIC - DW	Tube	SN74CBTD3384DW	CBTD3384	
	SOIC - DW	Tape and reel	SN74CBTD3384DWR	CB1D3364	
–40°C to 85°C	SSOP – DB	Tape and reel	SN74CBTD3384DBR	CC384	
-40°C to 85°C	SSOP (QSOP) – DBQ	Tape and reel	SN74CBTD3384DBQR	CBTD3384	
	TSSOP – PW	Tape and reel	SN74CBTD3384PWR	CC384	
	TVSOP – DGV	Tape and reel	SN74CBTD3384DGVR	CC384	
	CDIP – JT	Tube	SNJ54CBTD3384JT	SNJ54CBTD3384JT	
–55°C to 125°C	CFP – W	Tube	SNJ54CBTD3384W	SNJ54CBTD3384W	
	LCCC – FK	Tube	SNJ54CBTD3384FK	SNJ54CBTD3384FK	

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

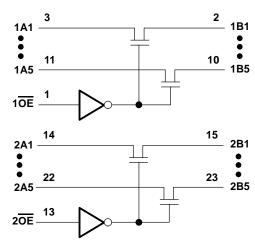


SCDS025P - MAY 1995 - REVISED JUNE 2001

FUNCTION TABLE (each 5-bit bus switch)

INP	UTS	INPUTS/OUTPUTS			
10E	2OE	1B1-1B5 2B1-2B			
L	L	1A1-1A5	2A1-2A5		
L	Н	1A1-1A5	Z		
Н	L	Z	2A1-2A5		
Н	Н	Z	Z		

logic diagram (positive logic)



Pin numbers shown are for the DB, DBQ, DGV, DW, JT, PW, and W packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}		0.5 V to 7 V
Input voltage range, V _I (see Note 1)		0.5 V to 7 V
Continuous channel current		
Input clamp current, I_{IK} ($V_{I/O} < 0$)		
Package thermal impedance, θ _{JA} (see Note 2):	DB package	63°C/W
-	DBQ package	61°C/W
	DGV package	86°C/W
	DW package	46°C/W
	PW package	88°C/W
Storage temperature range, T _{stg}		–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.



recommended operating conditions (see Note 3)

			SN54CBTD3384		SN74CBTD3384	
		MIN	MAX	MIN	MAX	UNIT
Vcc	Supply voltage	4.5	5.5	4.5	5.5	V
VIH	High-level control input voltage	2		2		V
VIL	Low-level control input voltage		0.8		0.8	V
TA	Operating free-air temperature	-55	125	-40	85	°C

In applications with fast edge rates, multiple outputs switching, and operating at high frequencies, the output may have little or no level-shifting effect.

NOTE 3: All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		SN54CBTD3384		SN74CBTD3384			UNIT		
				MIN	TYP [†]	MAX	MIN	TYP†	MAX	UNII	
VIK		$V_{CC} = 4.5 \text{ V},$	I _I = -18 mA				-1.2			-1.2	V
Vон		See Figure 2									
II		$V_{CC} = 5.5 \text{ V},$	$V_{CC} = 5.5 \text{ V}, V_{I} = 5.5 \text{ V or GND}$				±1			±1	μΑ
Icc		$V_{CC} = 5.5 \text{ V},$	I _O = 0,	$V_I = V_{CC}$ or GND			1.5			1.5	mA
∆lcc [‡]	Control inputs	$V_{CC} = 5.5 \text{ V}$, One input at 3.4 V, Other inputs at V_{CC} or GND			-	2.5			2.5	mA	
Ci	Control inputs	V _I = 3 V or 0			3			3		pF	
C _{io(OFF}	=)	$V_0 = 3 \text{ V or } 0,$	OE = V _{CC}			3.5			3.5		pF
		ν.	V. 0	I _I = 64 mA		5			5	7	
r _{on} §		V _{CC} = 4.5 V	V _I = 0	I _I = 30 mA		5			5	7	Ω
			$V_{I} = 2.4 V$,	I _I = 15 mA		35			35	50	

[†] Typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	SN54CBT	D3384	SN74CBTD3384		UNIT
	(INPUT)	(OUTPUT)	MIN	MAX	MIN	MAX	UNII
$t_{pd}\P$	A or B	B or A		0.25		0.25	ns
^t en	ŌĒ	A or B	2.2	9.7	2.3	7	ns
^t dis	OE .	A or B	1.5	8.6	1.7	5.3	ns

The propagation delay is the calculated RC time constant of the typical on-state resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).

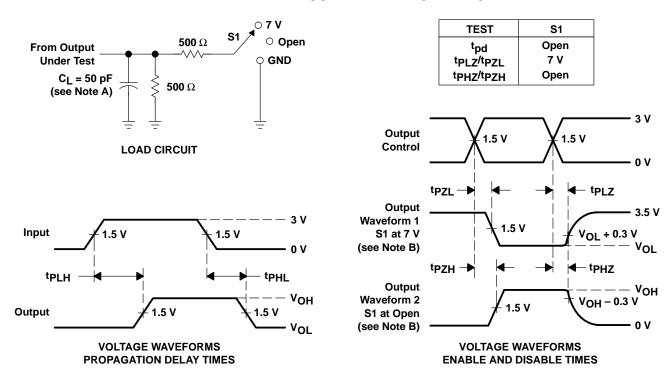


[‡] This is the increase in supply current for each input that is at the specified TTL voltage level rather than VCC or GND.

[§] Measured by the voltage drop between the A and B terminals at the indicated current through the switch. On-state resistance is determined by the lowest voltage of the two (A or B) terminals.

SCDS025P - MAY 1995 - REVISED JUNE 2001

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

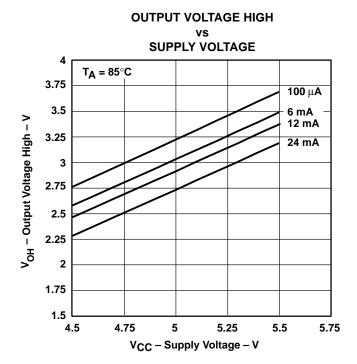
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_{O} = 50 \Omega$, $t_{f} \leq$ 2.5 ns, $t_{f} \leq$ 2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 1. Load Circuit and Voltage Waveforms



OUTPUT VOLTAGE HIGH

TYPICAL CHARACTERISTICS



SUPPLY VOLTAGE T_A = 25°C 3.75 100 μ A 3.5 V_{OH} - Output Voltage High - V 6 mA 3.25 12 mA 24 mA 3 2.75 2.5 2.25 2 1.75 1.5 ^L 4.5 4.75 5.25 5.5 5.75 V_{CC} – Supply Voltage – V

OUTPUT VOLTAGE HIGH vs SUPPLY VOLTAGE

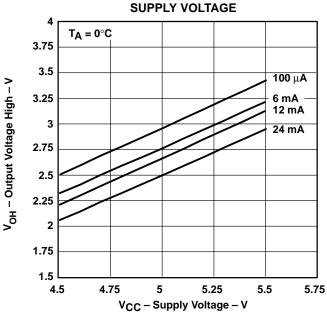


Figure 2. V_{OH} Values

IMPORTANT NOTICE

Texas Instruments and its subsidiaries (TI) reserve the right to make changes to their products or to discontinue any product or service without notice, and advise customers to obtain the latest version of relevant information to verify, before placing orders, that information being relied on is current and complete. All products are sold subject to the terms and conditions of sale supplied at the time of order acknowledgment, including those pertaining to warranty, patent infringement, and limitation of liability.

TI warrants performance of its products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

Customers are responsible for their applications using TI components.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance or customer product design. TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such products or services might be or are used. TI's publication of information regarding any third party's products or services does not constitute TI's approval, license, warranty or endorsement thereof.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations and notices. Representation or reproduction of this information with alteration voids all warranties provided for an associated TI product or service, is an unfair and deceptive business practice, and TI is not responsible nor liable for any such use.

Resale of TI's products or services with <u>statements different from or beyond the parameters</u> stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service, is an unfair and deceptive business practice, and TI is not responsible nor liable for any such use.

Also see: Standard Terms and Conditions of Sale for Semiconductor Products, www.ti.com/sc/docs/stdterms.htm

Mailing Address:

Texas Instruments Post Office Box 655303 Dallas, Texas 75265